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For two-letter codes and other abbreviations, refer to the "Guidance Notes on Codes and Abbreviations" appearing at the beginning of each regular issue of the PCT Gazette.

A1

(54) Title: ADHESIVE COMPOSITION

(57) Abstract: An adhesive composition for use in the manufacture of wood-based boards, said adhesive composition containing resin and a foaming agent, and said composition being foamable. According to the invention, the adhesive composition contains 40 - 80 w-% resin, 5 - 30 w-% filler, 0 - 40 w-% solvent, and 0.1 - 10 w-% foaming agent, which has been selected from organic and/or inorganic surface-active sulfate, sulfonate, phosphate or phosphonate compounds or their derivatives or mixtures.

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ADHESIVE COMPOSITION

The present invention relates to an adhesive composition as defined in the preamble of claim 1, designed for use in the manufacture of wood-based sheets, such as plywood, scaleboard, blockboard, fibreboard, OBS board or equivalent.

In the present context, plywood refers to plywood, chipboard or a corresponding multi-layer product formed from at least three veneer layers placed one upon the other or crosswise and glued and pressed against each other to form plywood, chipboard or equivalent.

In prior art, various adhesives for use in woodboard industry are known. An example of known technology is the use of phenolic resin glues, such as phenol-formaldehyde resin, or urea resin glues as adhesives. Another known technique is to add a foaming agent to an adhesive in order to foam the adhesive composition before its delivery for application in the gluing of woodboard. A preferred known foaming agent used is dried blood. A problem with the use of dried blood are the ethical questions involved. Moreover, when dried blood is used, it may be necessary to add a separate surface tension reducing agent to the adhesive composition in order to achieve the desired properties. A further problem in the use of dried blood is that it is added to the filler or hardener of the adhesive composition in a powdery form, which is why it is difficult to achieve a perfect homogeneity of the composition.

Various other adhesive compositions not containing dried blood as a foaming agent have also been tried in woodboard industry. However, so far no composition of sufficient quality and efficiency has been found that contains no dried blood and has gluing

properties and a price and durability suited for use in the manufacture of wood-based boards.

A further problem in the use of prior-art adhesive compositions is their poor durability, which is 5 why the compositions have to be mixed just before use. In addition, the adhesive concentration in prior-art compositions is conventionally low, and therefore eventual impurities can contaminate the adhesive composition more easily.

10 The object of the present invention is to overcome the above-mentioned drawbacks concerning an adhesive composition in connection with the manufacture of wood-based boards. A specific object of the invention is to disclose a new, more effective and 15 more ethical adhesive composition.

The adhesive composition of the invention is characterized by what is disclosed in the claims.

The invention is based on an adhesive composition used in the manufacture of wood-based boards. 20 The adhesive composition contains resin, a filler, a foaming agent and a solvent, and it is foamable. According to the invention, the adhesive composition contains 40 - 80 w-% resin, 5 - 30 w-% filler, 0 - 40 w-% solvent and 0.1 - 10 w-% foaming agent, which has 25 been selected from organic and/or inorganic surface-active sulfate, sulfonate, phosphate or phosphonate compounds or their derivatives or their mixtures.

In an embodiment of the invention, the foaming agent used is lauryl sulfate, lauryl ether sulfate 30 or benzene sulfate or a compound, derivative or mixture of these or the like. In an embodiment, the lauryl sulfate or lauryl ether sulfate has been selected from the group: sodium lauryl sulfate, ammonium lauryl sulfate, potassium lauryl sulfate, sodium 35 lauryl ether sulfate, ammonium lauryl ether sulfate, potassium lauryl ether sulfate, a derivative of these or a mixture of these or the like.

In an embodiment of the invention, the foaming agent used is a substance selected from the group: sodium isopropyl sulfonate, sodium lauryl sulfonate, sodium benzene sulfonate, sodium alkyl benzene sulfonate, ammonium lauryl phosphate, ammonium lauryl sulfonate, potassium olein sulfate, sodium naphthalene sulfonate or a compound, derivative or mixture of these or the like.

Alternatively, it is possible to use any corresponding surface-active compound as a foaming agent. In this connection, the purpose of the surface-active compound is expressly to promote its foaming.

In a preferred embodiment of the invention, the adhesive composition contains 0.1 - 5 w-% foaming agent.

In a preferred embodiment, the adhesive composition contains 1 - 10 w-% foaming agent, of which 0.1 - 30 w-% is lauryl sulfate, lauryl ether sulfate, benzene sulfate or their compounds, derivatives or mixtures.

In an embodiment of the invention, the resin, i.e. the actual adhesive used may preferably consist of phenol-formaldehyde resins, urea-formaldehyde resins, amino resins or other corresponding resins. In an embodiment, the resin used is UF (urea-formaldehyde resin), MUF (melamine urea-formaldehyde), MUFP, PF (phenol-formaldehyde), PMF or PRF or a derivative or mixture of these or equivalent.

In a preferred embodiment of the invention, the adhesive composition contains 50 - 70 w-% resin.

In an embodiment of the invention, the adhesive composition contains a filler, preferably in an amount of 8 - 20 w-%.

In this context, filler refers to a filling agent or hardener known in itself or to a mixture of these. The hardener effects the hardening of the glue in the application, i.e. during the manufacturing of

wood-based boards, often preferably together with heat of compression. In an embodiment, the filler used is starch, wheat flower, chalk, sodium carbonate, potassium carbonate, calcium carbonate, ammonium sulfate, 5 wood powder, quebracho or a derivative of these or a mixture of these or equivalent. Quebracho means the hard wood material of certain South-American broadleaf trees. Chalk in this connection refers to loose-structured, light and crumbling limestone.

10 In an embodiment of the invention, the adhesive composition contains a solvent, preferably in an amount of 12 - 35 w-%. In a preferred embodiment, the solvent is water. The water may be obtained from outside the process or it may be water circulated from 15 within the process, i.e. process wash water. In an alternative embodiment, the solvent is an organic solvent.

20 In an embodiment of the invention, the adhesive composition contains air, preferably pressurized air, added to it to achieve more effective formation of foam.

25 In an embodiment, the adhesive composition contains a separate surface-active substance not intended purely for the purpose of foaming, preferably in an amount of 0.1 - 2 w-%.

In an embodiment, the adhesive composition contains a catalyst.

30 In a preferred embodiment of the invention, the foaming agent is in solid, liquid or paste-like state. In an embodiment, the foaming agent is added as such or in the form of a solution into the adhesive composition.

35 In a preferred embodiment, the adhesive composition is an emulsion. In an embodiment of the invention, the adhesive composition has been formed by mixing the resin, filler, foaming agent and solvent together to produce an emulsion, e.g. a water emul-

sion. In an embodiment, the resin, filler, foaming agent and solvent are mixed at a high temperature, e.g. over 40 °C.

5 In an embodiment, the mixture or emulsion has a high adhesive concentration.

The invention makes it possible to produce a more effective and more ethical adhesive composition. The invention has the advantage that a composition having a very good foamability and allowing a very 10 good control of foamability is achieved.

According to the invention, the adhesive composition contains resin, a foaming agent, a solvent and/or a filler; no separate additives are needed. A further advantage of the invention is that the foaming 15 agent is in liquid phase, allowing a very homogeneous adhesive composition to be produced when the components forming the composition are mixed to form a liquid adhesive mixture.

A further advantage of the invention is that 20 the adhesive has a good and fast spreadability on the surface to be glued. The adhesive is not viscous and it divides easily when being spread. This means a reduced consumption of adhesive.

An additional advantage of the adhesive composition is good durability because adhesive concentration of the composition is substantially higher 25 than in prior-art adhesives and in addition because the adhesive mixture or emulsion has been preferably formed by mixing the liquid components together and 30 cooking the mixture preferably at a relatively high temperature (over 40 °C). The adhesive composition is preserved substantially unchanged for as long as several weeks. Moreover, the composition is not sensitive to impurities, microbes or equivalent.

35 The adhesive composition of the invention is applicable for use in the manufacture of various wood-based boards in different conditions.

In the following, the invention will be described with reference to detailed embodiment examples.

5 Example 1

In an experiment, an adhesive composition was prepared. Phenol formaldehyde resin (52 w-%), filling agent (8.7 w-%) and ammonium lauryl sulfate (1.7 w-%) 10 and a solvent (water, 37.3 w-%) were mixed together to form a water mixture. The filling agent was a mixture of calcium carbonate, starch and wheat meal.

The mixture thus produced had good foaming characteristics.

15

Example 2

In an experiment, an adhesive composition as in Example 1 was prepared in a corresponding manner. 20 As an exception to Example 1, the ammonium lauryl sulfate used in this experiment was added directly as a water emulsion. The mixture had a composition corresponding to Example 1. The mixture produced had foaming characteristics substantially as good as those of 25 the mixture in Example 1.

Example 3

In an experiment, phenol formaldehyde resin 30 (50 w-%), filling agent (10 w-%) (as in Example 1), sodium alkyl benzene sulfonate (5.2 w-%) and a solvent (water, 34.8 w-%) were mixed together. The mixture thus produced had a good foamability.

35

Example 4

In an experiment, an adhesive composition as in Example 3 was prepared. As an exception to Example 5 3, the foaming agent used in this experiment was a mixture of sodium alkyl benzene sulfonate and ammonium lauryl sulfonate. In this case, the total amount of foaming agents needed to produce a foam could be halved. In the composition of the mixture thus produced, 10 the water content was 37.4 w-% and the foaming agent content was 2.6 w-%.

As a result, a mixture having a good foamability was achieved.

15 Example 5

In an experiment, an adhesive composition was prepared. Phenol-formaldehyde resin (56.8 w-%), filler (18.5 w-%) and ammonium lauryl sulfate (0.5 w-%) and 20 water (24.2 w-%) were mixed together to form a water mixture. The filler was a mixture of starch, chalk, quebracho, potassium carbonate and ammonium sulfate. Alternatively, instead of ammonium lauryl sulfate, it is possible to use sodium lauryl sulfate as a foaming 25 agent.

The mixture thus produced had still better foaming properties and a better stability than the adhesive compositions in examples 1 - 4.

30 Example 6

In an experiment, an adhesive composition was prepared. Phenol-formaldehyde resin (65 w-%), filler (11 w-%) and sodium lauryl sulfate (0.9 w-%) and water 35 (23 w-%) were mixed together to form a water mixture. The filler was a mixture of starch and wood powder.

The foaming properties and stability of the mixture thus produced were as good as those of the adhesive composition in example 5.

5 Example 7

In an experiment, an adhesive composition was prepared. Phenol-formaldehyde resin (50 w-%), filler (28 w-%), a mixture (0.7 w-%) of sodium lauryl sulfate 10 and sodium lauryl ether sulfate and water (21.3 w-%) were mixed together to form a water mixture. The filler was a mixture of starch, wheat meal, sodium carbonate and calcium carbonate.

The mixture thus produced had good foaming 15 properties and a good stability.

Example 8

In an experiment, an adhesive composition was 20 prepared. Phenol-formaldehyde resin (67.5 w-%), filler (12.15 w-%) and sodium lauryl ether sulfate (0.35 w-%) and water (20 w-%) were mixed together to form a water mixture. The filler was a mixture of starch, wheat meal and wood powder.

25 The foaming properties and stability of the mixture thus produced were as good as those of the adhesive compositions in examples 5 and 6.

Example 9

30 In an experiment, an adhesive composition was prepared. Phenol-formaldehyde resin (70 w-%), filler (15 w-%) and a foaming agent mixture (3.0 w-%) containing 21 % sodium lauryl sulfate, and water (12 w-%) 35 were mixed together to form a water mixture.

The mixture thus produced had good foaming properties.

The adhesive composition of the invention is suited for use as different applications for the manufacture of various wood-based boards.

5 The embodiments of the invention are not limited to the examples presented above; instead, they may be varied within the scope of the following claims.

CLAIMS

1. Adhesive composition for use in the manufacture of wood-based boards, said adhesive composition containing resin, a filler, a foaming agent and a solvent, and said composition being foamable, characterized in that the adhesive composition contains 40 - 80 w-% resin, 5 - 30 w-% filler, 0 - 40 w-% solvent, and 0.1 - 10 w-% foaming agent selected from organic and/or inorganic surface-active sulfate, sulfonate, phosphate or phosphonate compounds or their derivatives or mixtures.

2. Adhesive composition according to claim 1, characterized in that the foaming agent is lauryl sulfate, lauryl ether sulfate, benzene sulfate or a compound, derivative or mixture of these.

3. Adhesive composition according to claim 2, characterized in that the lauryl sulfate or lauryl ether sulfate has been selected from the group: sodium lauryl sulfate, ammonium lauryl sulfate, potassium lauryl sulfate, sodium lauryl ether sulfate, ammonium lauryl ether sulfate, potassium lauryl ether sulfate, a derivative of these or a mixture of these or the like.

4. Adhesive composition according to claim 1 or 2, characterized in that the foaming agent has been selected from the group: sodium isopropyl sulfonate, sodium lauryl sulfonate, sodium benzene sulfonate, sodium alkyl benzene sulfonate, ammonium lauryl phosphate, ammonium lauryl sulfonate, potassium olein sulfate, sodium naphthalene sulfonate or a compound, derivative or mixture of these or the like.

5. Adhesive composition according to any one of claims 1 - 4, characterized in that the composition contains 0.1 - 5 w-% foaming agent.

35 6. Adhesive composition according to any one of claims 1 - 5, characterized in that the adhesive composition contains 1 - 10 w-% foaming agent,

of which 0.1 - 30 w-% consists of lauryl sulfate, lauryl ether sulfate, benzene sulfate or compounds, derivatives or mixtures of these.

7. Adhesive composition according to any one
5 of claims 1 - 6, characterized in that the
resin has been selected from the group: UF, MUF, MUFP,
PF, PMF, PRF, a derivative of these or a mixture of
these or the like.

8. Adhesive composition according to any one
10 of claims 1 - 7, characterized in that the
composition contains 50 - 70 w-% resin.

9. Adhesive composition according to any one
of claims 1 - 8, characterized in that the
composition contains 8 - 20 w-% filler.

15 10. Adhesive composition according to any one
of claims 1 - 9, characterized in that the
filler has been selected from the group: starch, wheat
meal, chalk, sodium carbonate, potassium carbonate,
calcium carbonate, ammonium sulfate, wood powder, que-
20 bracho or a derivative or mixture of these or the
like.

11. Adhesive composition according to any one
of claims 1 - 10, characterized in that the
composition contains 12 - 35 w-% solvent.

25 12. Adhesive composition according to any one
of claims 1 - 11, characterized in that the
solvent is water or an organic solvent.

13. Adhesive composition according to any one
of claims 1 - 12, characterized in that the
30 adhesive composition contains air added to it.

14. Adhesive composition according to any one
of claims 1 - 13, characterized in that the
foaming agent is in solid, liquid or paste-like state.

15. Adhesive composition according to any one
35 of claims 1 - 14, characterized in that the
adhesive composition has been produced by mixing the

resin, filler, foaming agent and solvent together to form an emulsion.

16. Adhesive composition according to any one of claims 1 - 15, characterized in that the 5 adhesive composition has been produced by mixing the resin, filler, foaming agent and solvent together at a temperature of over 40 °C.

INTERNATIONAL SEARCH REPORT

International application No.

PCT/FI 2004/000177

A. CLASSIFICATION OF SUBJECT MATTER

IPC7: C08J 5/08

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

IPC7: C08J

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

SE,DK,FI,NO classes as above

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

WPI, EPODOC, PAJ

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	WO 9946349 A1 (NESTE OY), 16 Sept 1999 (16.09.1999) --	1-16
X	US 5695823 A (OSCAR HSIEN-HSIANG HSU ET AL), 9 December 1997 (09.12.1997) --	1,3
A	WO 9831764 A1 (NESTE OY), 23 July 1998 (23.07.1998) --	1-16
A	US 3905921 A (CHARLES N. CONE ET AL), 16 Sept 1975 (16.09.1975) --	1-16

Further documents are listed in the continuation of Box C.

See patent family annex.

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Name and mailing address of the ISA/ Swedish Patent Office Box 5055, S-102 42 STOCKHOLM Facsimile No. + 46 8 666 02 86	Authorized officer Erika Stenroos/MP Telephone No. + 46 8 782 25 00

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International application No.
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C (Continuation). DOCUMENTS CONSIDERED TO BE RELEVANT

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